

DOUBLE ESD PROTECTION DIODE**DESCRIPTION**

The PESD3V3 is a double ESD protection diode in a SOT-23 package configuration. The device is designed to protect communications application from the effects of electrostatic discharge (ESD) and electrical fast transients (EFT).

FEATURES

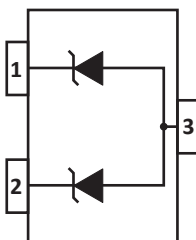
- Compatible with IEC 61000-4-2 (ESD): Air $\pm 30\text{kV}$, Contact $\pm 30\text{kV}$
- Compatible with IEC 61000-4-4 (EFT)
- Compatible with IEC 61000-4-5 (Surge): 25A
- 400 Watts Peak Pulse Power per Line ($t_p = 8/20\mu\text{s}$)
- Protects Two Unidirectional Lines or 1 Bidirectional Line
- Low Leakage Current $< 2.0\mu\text{A}$
- Low Capacitance
- RoHS Compliant
- REACH Compliant

APPLICATIONS

- Ethernet - 10/100 Base T
- Cellular Phones
- Audio/Video Inputs
- SMART Phones
- E1/T1 & E3/T3

MECHANICAL CHARACTERISTICS

- Molded JEDEC SOT-23 Package
- Approximate Weight: 8 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
Pure-Tin - Sn, 100: 260-270°C
- Flammability Rating UL 94V-0
- 8mm Tape and Reel per EIA Standard 481

PIN CONFIGURATION

TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ($t_p = 8/20\mu s$) - See Figure 1	P_{PP}	400	Watts
Operating Temperature	T_L	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{PP}	25	Amps

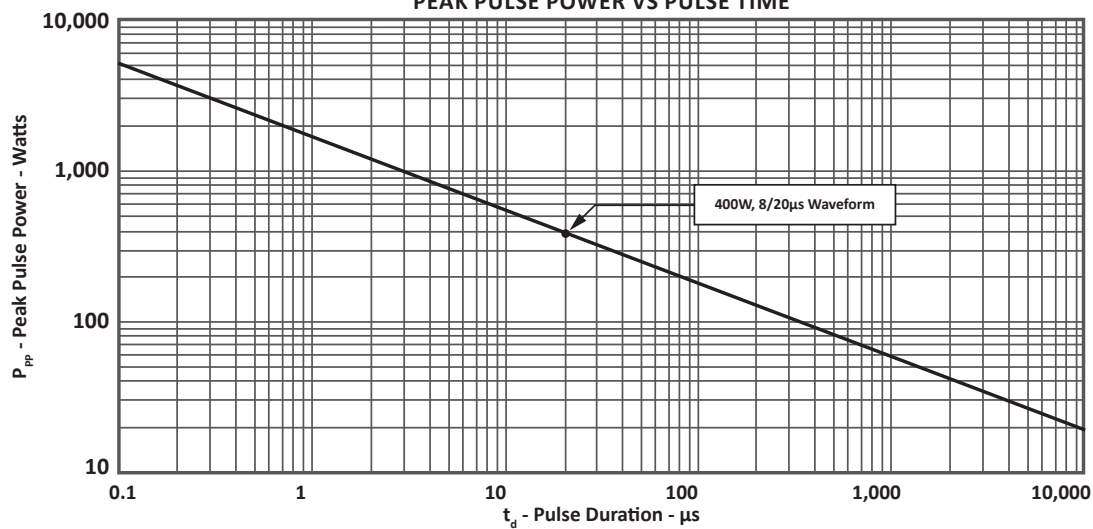
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER (Note 1)	DEVICE MARKING	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM SNAP BACK VOLTAGE @ $I_{SB} = 50mA$ V_{SB} VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ $I_P = 1A$ V_C VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ $I_P = 20A$ V_C VOLTS	MAXIMUM LEAKAGE CURRENT @ V_{WM} I_D μA	TYPICAL CAPACITANCE @ 0V, 1MHz C pF
PESD3V3	3V3	3.3	5.2	3.3	7.0	20.0	2	20

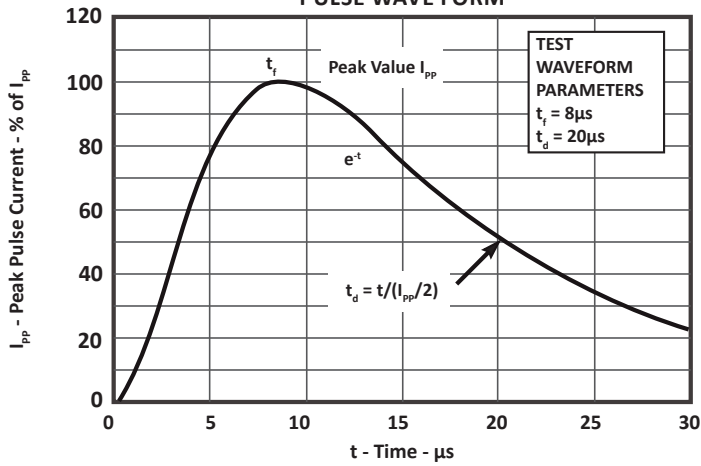
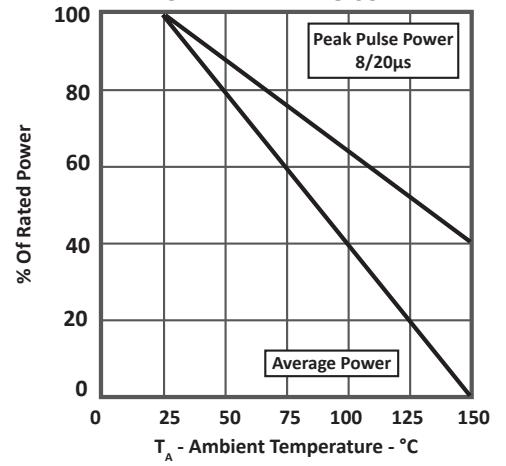
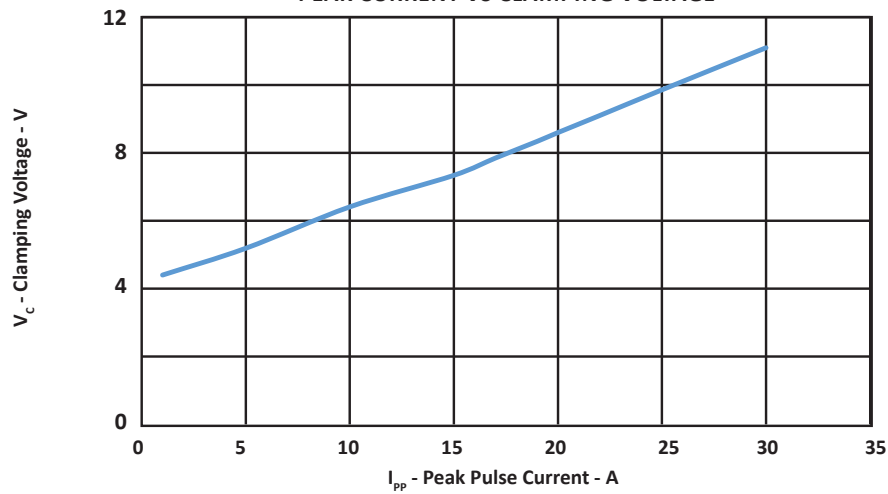
NOTES

1. Test between pins 2 to 3 and 1 to 3.

FIGURE 1
PEAK PULSE POWER VS PULSE TIME



TYPICAL DEVICE CHARACTERISTICS

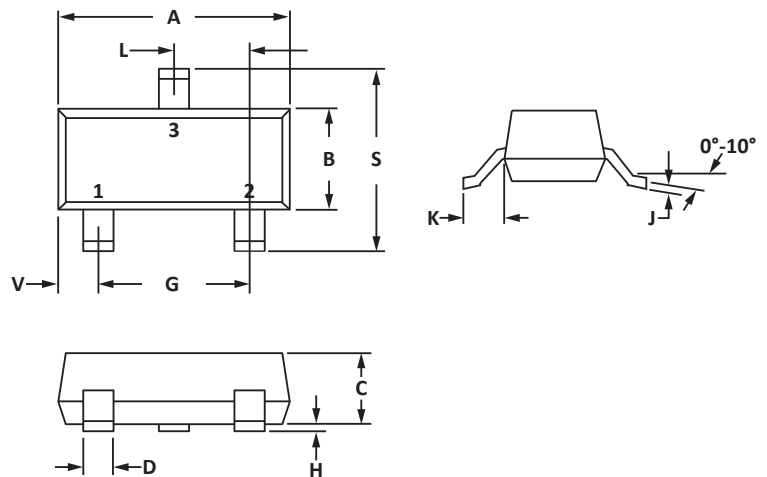
 FIGURE 2
 PULSE WAVE FORM

 FIGURE 3
 POWER DERATING CURVE

 FIGURE 4
 PEAK CURRENT VS CLAMPING VOLTAGE


SOT-23 PACKAGE INFORMATION
OUTLINE DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.80	3.04	0.110	0.120
B	1.20	1.40	0.047	0.055
C	0.89	1.11	0.035	0.044
D	0.37	0.50	0.015	0.020
G	1.78	2.04	0.070	0.081
H	0.013	0.100	0.001	0.004
J	0.085	0.177	0.003	0.007
K	0.45	0.60	0.018	0.024
L	0.89	1.02	0.035	0.040
S	2.10	2.50	0.083	0.098
V	0.45	0.60	0.018	0.024

NOTES

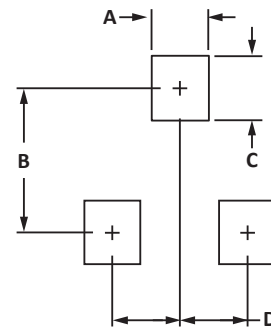
1. Controlling dimension: inches.
2. Dimensioning and tolerances per ANSI Y14.5M, 1985.
3. Pin 3 is the cathode (Unidirectional Only)
4. Dimensions are exclusive of mold flash and metal burrs.


PAD LAYOUT DIMENSIONS

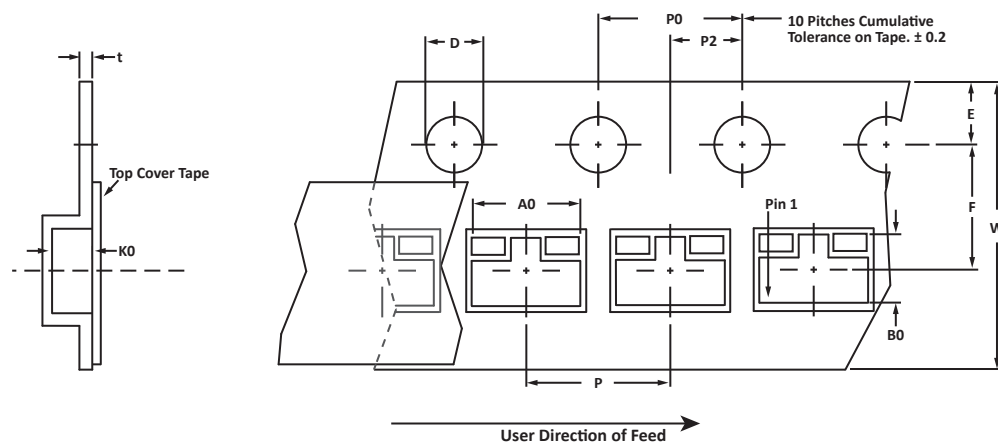
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.71	0.97	0.028	0.038
B	1.88	2.13	0.074	0.084
C	0.71	0.97	0.028	0.038
D	0.81	1.07	0.032	0.042

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS

REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	8mm	3.15 ± 0.10	2.77 ± 0.10	1.30 ± 0.10	1.55 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.228

NOTES

1. Dimensions are in millimeters.
2. Surface mount product is taped and reeled in accordance with EIA-481.
3. Suffix - T73 = 7" Reel - 3,000 pieces per 8mm tape.
4. Marking on Part - marking code (see page 2).

ORDERING INFORMATION

BASE PART NUMBER	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
PESD3V3	n/a	-T73	3000	7"	n/a

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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